International
IOR Rectifier

Data Sheet No. PD60029 revJ

IR2155&(PbF)

(NOTE: For new designs, we recommend IR's new products IR2153 and IR21531)

SELF-OSCILLATING HALF-BRIDGE DRIVER

Features

- Floating channel designed for bootstrap operation
  Fully operational to +600V
  Tolerant to negative transient voltage
  dV/dt immune
- Undervoltage lockout
- Programmable oscillator frequency

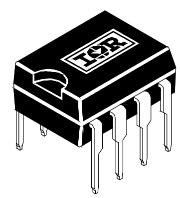
$$f = \frac{1}{1.4 \times (R_T + 150\Omega) \times C_T}$$

- Matched propagation delay for both channels
- Micropower supply startup current of 125 µA typ.
- Low side output in phase with R_T
- Available in Lead-Free

Product Summary

V_{OFFSET}	600V max.
Duty Cycle	50%
I_O+/-	210 mA / 420 mA
V_{OUT}	10 - 20V
Deadtime (typ.)	1.2 µs

Package

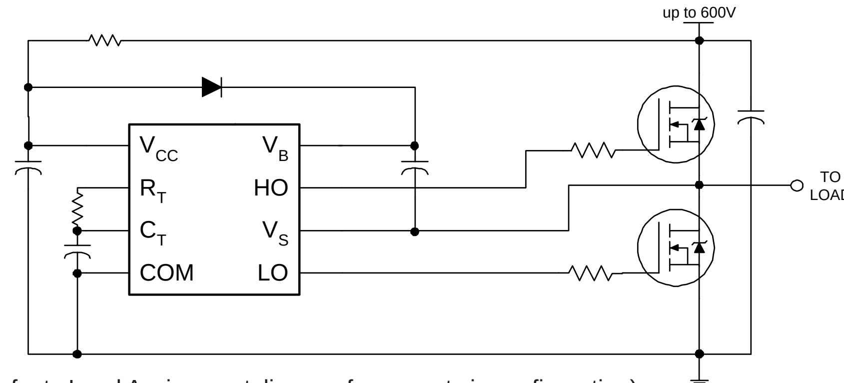


8 Lead PDIP

Description

The IR2155 is a high voltage, high speed, self-oscillating power MOSFET and IGBT driver with both high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The front end features a programmable oscillator which is similar to the 555 timer. The output drivers feature a high pulse current buffer stage and an internal deadtime designed for minimum driver cross-conduction. Propagation delays for the two channels are matched to simplify use in 50% duty cycle applications. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration that operates off a high voltage rail up to 600 volts.

Typical Connection



(Refer to Lead Assignment diagram for correct pin configuration)

Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

Symbol	Parameter Definition		Value Min.	Value Max.	Units
V_B	High Side Floating Supply Voltage		-0.3	625	V
V_S	High Side Floating Supply Offset Voltage		V_B - 25	V_B + 0.3	V
V_{HO}	High Side Floating Output Voltage		V_S - 0.3	V_B + 0.3	V
V_{LO}	Low Side Output Voltage		-0.3	V_{CC} + 0.3	V
V_{RT}	R_T Voltage		-0.3	V_{CC} + 0.3	V
V_{CT}	C_T Voltage		-0.3	V_{CC} + 0.3	V
I_{CC}	Supply Current (Note 1)		—	25	mA
I_{RT}	R_T Output Current		-5	5	mA
dV_S/dt	Allowable Offset Supply Voltage Transient		—	50	V/ns
P_D	Package Power Dissipation @ $T_A \leq +25°C$	(8 Lead DIP)	—	1.0	W
		(8 Lead SOIC)	—	0.625	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(8 Lead DIP)	—	125	°C/W
		(8 Lead SOIC)	—	200	°C/W
T_J	Junction Temperature		—	150	°C
T_S	Storage Temperature		-55	150	°C
T_L	Lead Temperature (Soldering, 10 seconds)		—	300	°C

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The V_S offset rating is tested with all supplies biased at 15V differential.

Symbol	Parameter Definition	Value Min.	Value Max.	Units
V_B	High Side Floating Supply Absolute Voltage	V_S + 10	V_S + 20	V
V_S	High Side Floating Supply Offset Voltage	—	600	V
V_{HO}	High Side Floating Output Voltage	V_S	V_B	V
V_{LO}	Low Side Output Voltage	0	V_{CC}	V
I_{CC}	Supply Current (Note 1)	—	5	mA
T_A	Ambient Temperature	-40	125	°C

Note 1: Because of the IR2155's application specificity toward off-line supply systems, this IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6V. Therefore, the IC supply voltage is normally derived by forcing current into the supply lead (typically by means of a high value resistor connected between the chip V_{CC} and the rectified line voltage and a local decoupling capacitor from V_{CC} to COM) and allowing the internal zener clamp circuit to determine the nominal supply voltage. Therefore, this circuit should not be driven by a DC, low impedance power source of greater than V_{CLAMP}.

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC}, V_{BS}) = 12V, C_L = 1000 pF and T_A = 25°C unless otherwise specified.

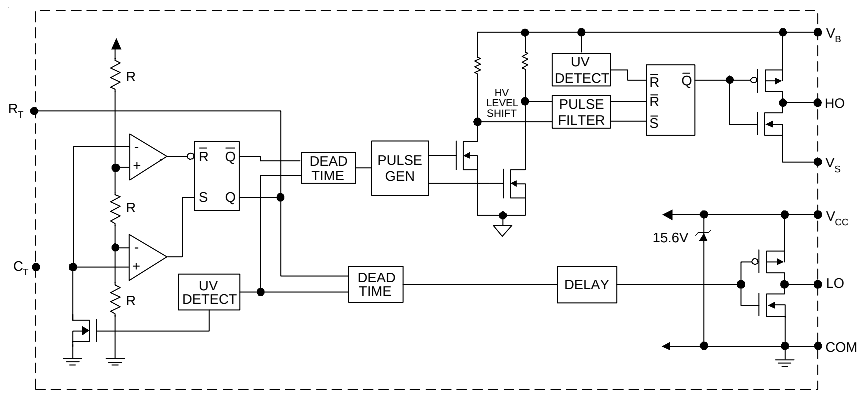
Symbol	Parameter Definition	Value Min.	Typ.	Max.	Units	Test Conditions
t_r	Turn-On Rise Time	—	80	120	ns	
t_r	Turn-Off Fall Time	—	40	70		
DT	Deadtime	0.50	1.20	2.25	µs	
D	R_T Duty Cycle	48	50	52	%	

Static Electrical Characteristics

V_{BIAS} (V_{CC}, V_{BS}) = 12V, C_L = 1000 pF, C_T = 1 nF and T_A = 25°C unless otherwise specified. The V_{IN}, V_{TH} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Parameter Definition	Value Min.	Typ.	Max.	Units	Test Conditions
f_{OSC}	Oscillator Frequency	19.4	20.0	20.6	kHz	R_T = 35.7 kΩ
		94	100	106		R_T = 7.04 kΩ
V_{CLAMP}	V_{CC} Zener Shunt Clamp Voltage	14.4	15.6	16.8	V	I_{CC} = 5 mA
V_{CT+}	2/3 V_{CC} Threshold	7.8	8.0	8.2		
V_{CT-}	1/3 V_{CC} Threshold	3.8	4.0	4.2		
V_{CTUV}	C_T Undervoltage Lockout	—	20	50	mV	2.5V < V_{CC} < V_{CCUV}
V_{RT+}	R_T High Level Output Voltage, V_{CC} - R_T	—	0	100		I_{RT} = -100 µA
		—	200	300		I_{RT} = -1 mA
V_{RT-}	R_T Low Level Output Voltage	—	20	50		I_{RT} = 100 µA
		—	200	300		I_{RT} = 1 mA
V_{RTUV}	RT Undervoltage Lockout, V_{CC} - R_T	—	0	100		2.5V < V_{CC} < V_{CCUV}
V_{OH}	High Level Output Voltage, V_{BIAS} - V_O	—	—	100		I_O = 0A
V_{OL}	Low Level Output Voltage, V_O	—	—	100		I_O = 0A
I_{LK}	Offset Supply Leakage Current	—	—	50	µA	V_B = V_S = 600V
I_{QBS}	Quiescent V_{BS} Supply Current	—	70	150		
I_{QBSUV}	Micropower V_{BS} Supply Startup Current	—	55	125		
I_{QCC}	Quiescent V_{CC} Supply Current	—	500	1000		
I_{QCCUV}	Micropower V_{CC} Supply Startup Current	—	70	150		
I_{CT}	C_T Input Current	—	0.001	1.0		
V_{BSUV+}	V_{BS} Supply Undervoltage Positive Going Threshold	7.7	8.4	9.2	V	
V_{BSUV-}	V_{BS} Supply Undervoltage Negative Going Threshold	7.3	8.1	8.9		
V_{BSUVH}	V_{BS} Supply Undervoltage Lockout Hysteresis	100	400	—	mV	
V_{CCUV+}	V_{CC} Supply Undervoltage Positive Going Threshold	7.7	8.4	9.2	V	
V_{CCUV-}	V_{CC} Supply Undervoltage Negative Going Threshold	7.4	8.1	8.9		
V_{CCUVH}	V_{CC} Supply Undervoltage Lockout Hysteresis	200	400	—	mV	
I_{O+}	Output High Short Circuit Pulsed Current	210	250	—	mA	V_O = 0V
I_{O-}	Output Low Short Circuit Pulsed Current	420	500	—		V_O = 15V

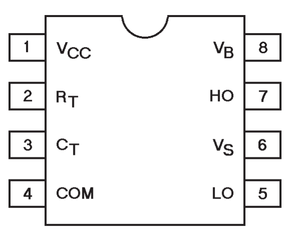
Functional Block Diagram



Lead Definitions

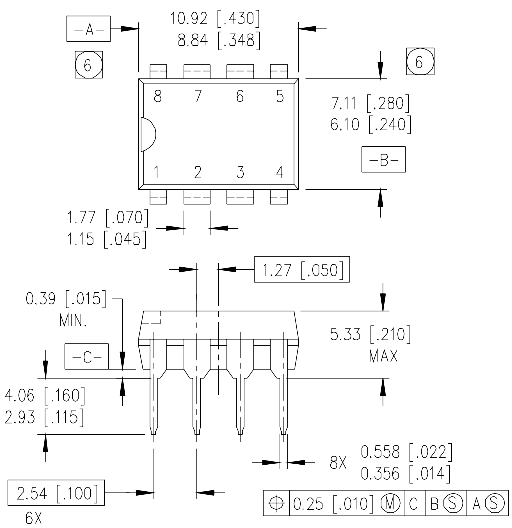
Lead Symbol	Description
R_T	Oscillator timing resistor input,in phase with LO for normal IC operation
C_T	Oscillator timing capacitor input, the oscillator frequency according to the following equation: $$f = \frac{1}{1.4 \times (R_T + 150\Omega) \times C_T}$$ where 150Ω is the effective impedance of the R_T output stage
V_B	High side floating supply
HO	High side gate drive output
V_S	High side floating supply return
V_{CC}	Low side and logic fixed supply
LO	Low side gate drive output
COM	Low side return

Lead Assignments



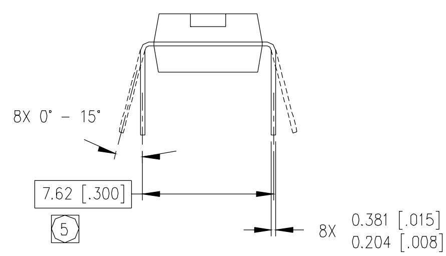
8 Lead DIP

IR2155



NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-001AB.
5. MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.
6. DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.25 [.010].



8 Lead PDIP

01-3003 01

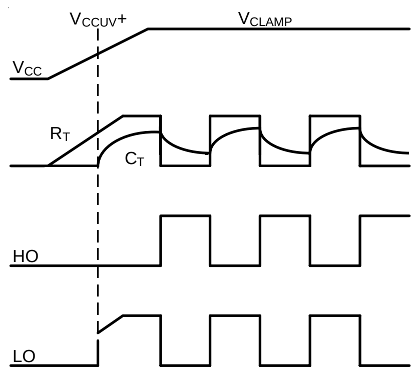


Figure 1. Input/Output Timing Diagram

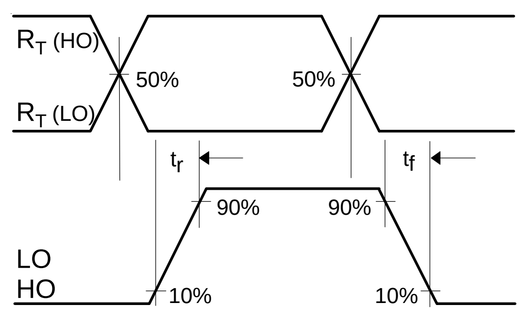


Figure 2. Switching Time Waveform Definitions

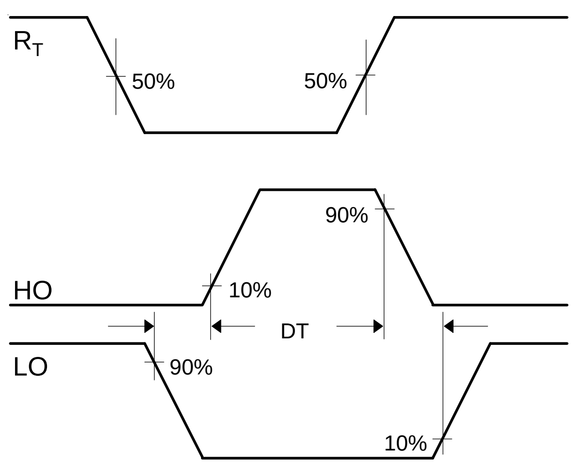
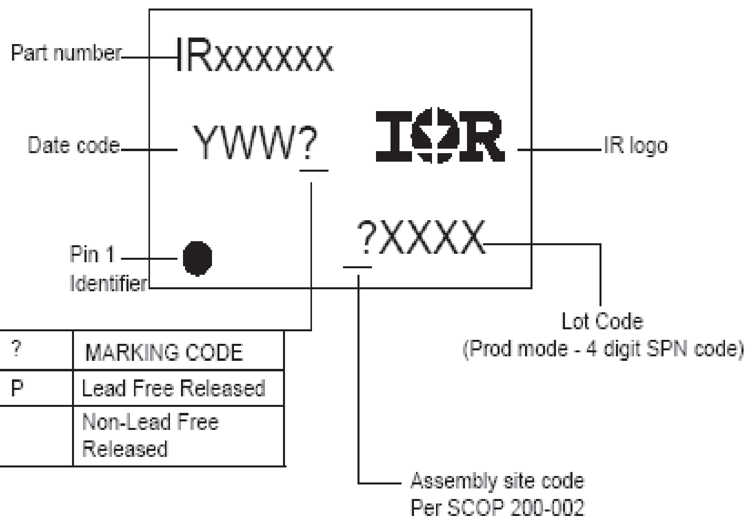


Figure 3. Deadtime Waveform Definitions

LEADFREE PART MARKING INFORMATION



?	MARKING CODE
P	Lead Free Released
	Non-Lead Free Released

ORDER INFORMATION

Basic Part (Non-Lead Free)

8-Lead PDIP IR2155 order IR2155

Lead-Free Part

8-Lead PDIP IR2155 order IR2155PbF

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This product has been designed and qualified for the Industrial market.
Qualification Standards can be found on IR's Web Site.
Data and specifications subject to change without notice.

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